LH534200B CMOS 4M (512K × 8) Mask Programmable ROM

FEATURES

- 524,288 × 8 bit organization
- Access time: 200 ns (MAX.)
- Power consumption:
  Operating: 275 mW (MAX.)
- Mask-programmable $OE_1/\overline{OE}_1/DC$
- Fully static operation
- TTL compatible I/O
- Three-state outputs
- Single +5 V power supply
- Packages:
  32-pin, 600-mil DIP
  Compatible with 28-pin 1M mask ROM-specific pinout

DESCRIPTION

The LH534200B is a mask programmable ROM organized as 524,288 × 8 bits. It is fabricated using silicon-gate CMOS process technology.

PIN CONNECTIONS

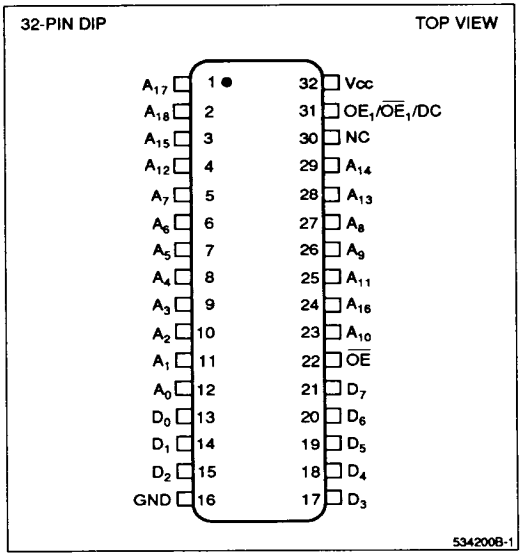

Figure 1. Pin Connections for DIP Package

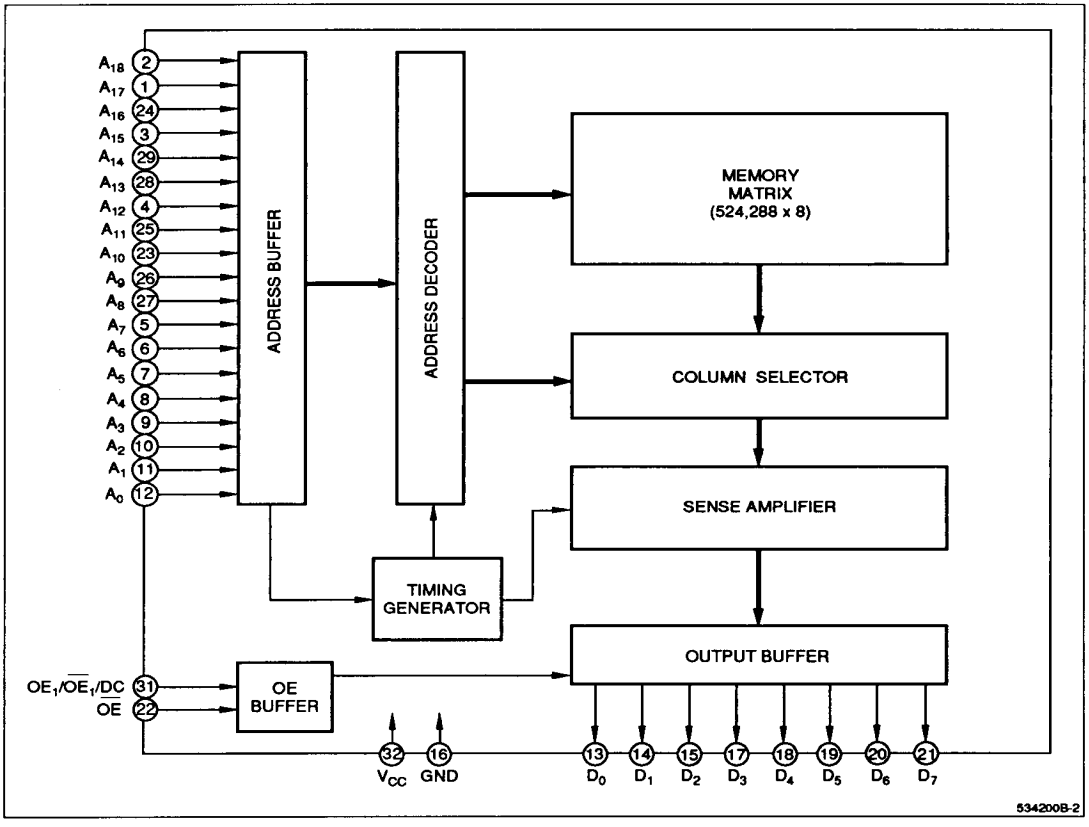

Figure 2. LH534200B Block Diagram

PIN DESCRIPTION

SIGNAL	PIN NAME	NOTE
A_0 - A_{18}	Address input	
D_0 - D_7	Data output	
$\overline{OE}$	Output Enable input	

SIGNAL	PIN NAME	NOTE
$OE_1/\overline{OE}_1/DC$	Output Enable input/ Don't Care	1
V_{CC}	Power supply (+5 V)	
GND	Ground	

NOTE:

1. The active level of $OE_1/\overline{OE}_1/DC$ is mask programmable.
   Selecting DC allows the outputs to be active for both high and low levels that are applied to this pin.
   It is recommended to apply either a HIGH or a LOW to the DC pin.

CAUTION

To stabilize the power supply, it is recommended that a high-frequency bypass capacitor be connected between the V_{CC} pin and the GND pin.

TRUTH TABLE

$\overline{OE}$	$OE_1/\overline{OE_1}$	MODE	D_0 - D_7	SUPPLY CURRENT
H	X	Non selected	High-Z	Operating (Icc)
X	L/H	Non selected	High-Z	Operating (Icc)
L	H/L	Selected	DOUT	Operating (Icc)

NOTE:
X = H or L

ABSOLUTE MAXIMUM RATINGS

PARAMETER	SYMBOL	RATING	UNIT	NOTE
Supply voltage	V_{CC}	-0.3 to +7.0	V	1
Input voltage	V_{IN}	-0.3 to V_{CC} +0.3	V	
Output voltage	V_{OUT}	-0.3 to V_{CC} +0.3	V	
Operating temperature	Topr	0 to +70	°C	
Storage temperature	Tstg	-55 to +150	°C	

NOTE:
1. The maximum applicable voltage on any pin with respect to GND.

RECOMMENDED OPERATING CONDITIONS (T_A = 0 to +70°C)

PARAMETER	SYMBOL	MIN.	TYP.	MAX.	UNIT
Supply voltage	V_{CC}	4.5	5.0	5.5	V

DC CHARACTERISTICS (V_{CC} = 5 V ± 10%, T_A = 0 to +70°C)

PARAMETER	SYMBOL	CONDITIONS	MIN.	TYP.	MAX.	UNIT	NOTE
Input "Low" voltage	V_{IL}		-0.3		0.8	V	
Input "High" voltage	V_{IH}		2.2		V_{CC} +0.3	V	
Output "Low" voltage	V_{OL}	I_{OL} = 2.0 mA			0.4	V	
Output "High" voltage	V_{OH}	I_{OH} = -400 µA	2.4			V	
Input leakage current	$\lvert I_{LI} \rvert$	V_{IN} = 0 V to V_{CC}			10	µA	
Output leakage current	$\lvert I_{LO} \rvert$	V_{OUT} = 0 V to V_{CC}			10	µA	1
Operating current	I_{CC1}	t_{RC} = 200 ns			50	mA	2
	I_{CC2}	t_{RC} = 1 µs			45		
	I_{CC3}	t_{RC} = 200 ns			45	mA	3
	I_{CC4}	t_{RC} = 1 µs			40		

NOTES:
1. $\overline{OE}/\overline{OE_1}$ = V_{IH} or OE_1 = V_{IL}
2. V_{IN} = V_{IH}/V_{IL}, outputs open
3. V_{IN} = (V_{CC} - 0.2 V) or 0.2 V, outputs open

AC CHARACTERISTICS (V_{CC} = 5 V ± 10%, T_A = 0 to +70°C)

PARAMETER	SYMBOL	MIN.	MAX.	UNIT	NOTE
Read cycle time	t_{RC}	200		ns	
Address access time	t_{AA}		200	ns	
Output enable time	t_{OE}		80	ns	
Output hold time	t_{OH}	10		ns	
OE to output in High-Z	t_{OHZ}		80	ns	1

NOTE:
1. This is the time required for the outputs to become high-impedance.

AC TEST CONDITIONS

PARAMETER	RATING
Input voltage amplitude	0.6 V to 2.4 V
Input rise/fall time	10 ns
Input reference level	1.5 V
Output reference level	0.8 V and 2.2 V
Output load condition	1TTL +100 pF

CAPACITANCE (V_{CC} = 5 V ± 10%, f = 1 MHz, T_A = 25°C)

PARAMETER	SYMBOL	MIN.	TYP.	MAX.	UNIT
Input capacitance	C_{IN}			10	pF
Output capacitance	C_{OUT}			10	pF

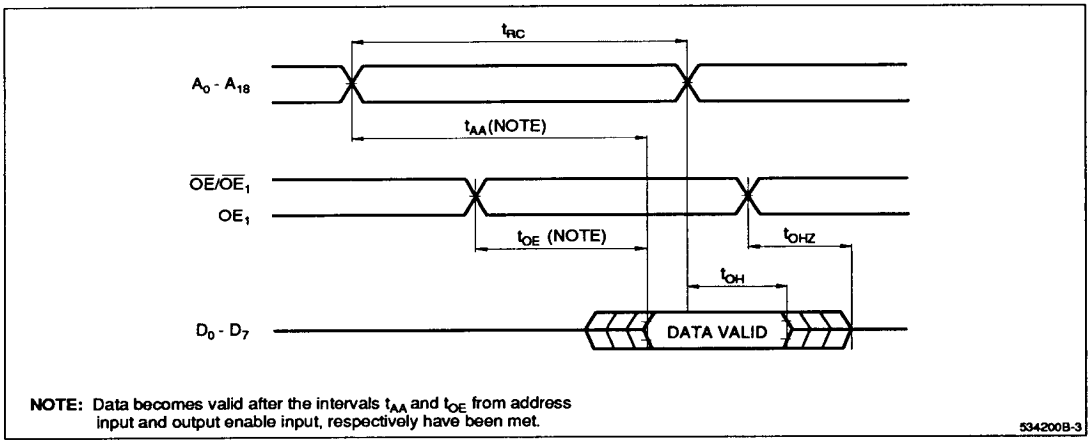

Figure 3. Timing Diagram

ORDERING INFORMATION